

Key Results of International Cooperation on Semiconductors for European Economic Resilience

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INTRODUCTION

- ICOS Project started in January 2023, it is funded by the Horizon Europe research program.

Coordinator



Technical co-Coordinator



- An ambitious project in the framework of the European strategy for semiconductors

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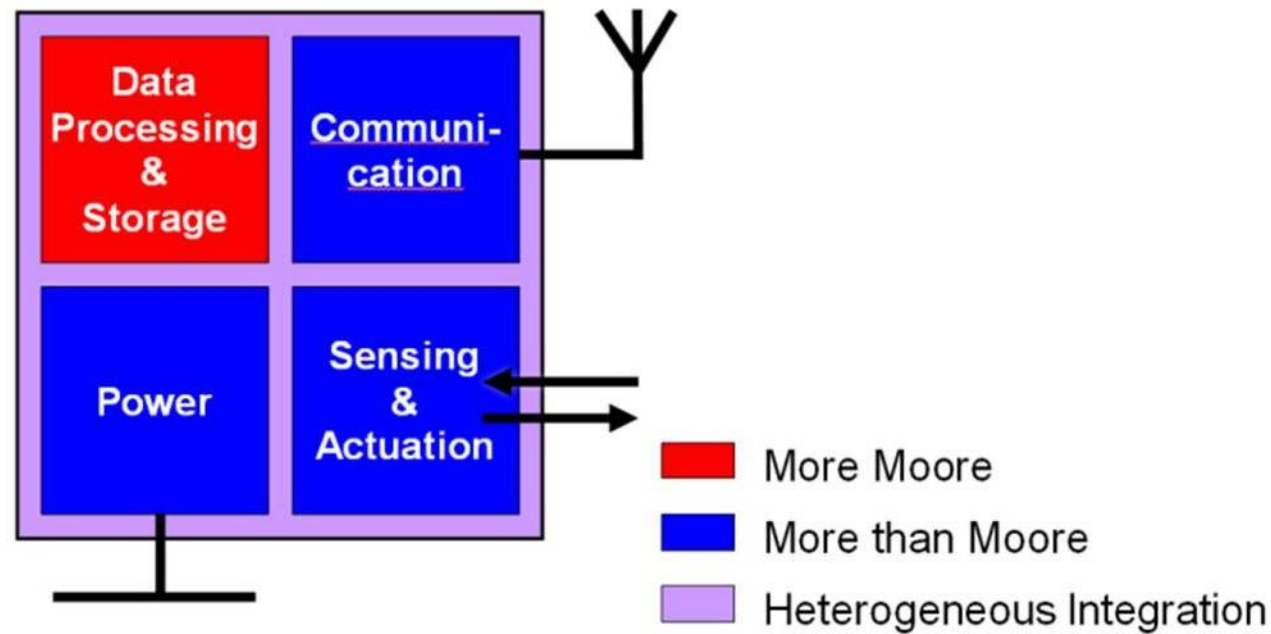


Paolo Gargini
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Main Scientific Topics

- Advanced computing & Advanced functionalities: sensing, RF & optical communications, optical devices, energy harvesting, power devices, ...



Motivation for International Cooperation in Semiconductor

- **Semiconductors & Semiconductor-based photonics** are pivotal technologies for almost all existing industrial sectors, as demonstrated by the recent chips shortages
- **International cooperation** is key for:
 - knowledge** exchange
 - speeding up** technological innovation (e.g. ITRS/IRDS, IPSR-I, ECS-SRIA, NEREID): computing needs, energy efficiency, advanced functionalities, heterogeneous integration
 - addressing the EU's technological gaps**
 - reducing cost** by avoiding duplicated research
 - strengthening** complex **supply and value chains** (no region can cover the whole value chain)
 - manage **risks** due to the turbulent geopolitical context
 - is encouraged by the new **strategies** of leading semiconductor countries (**digital partnerships**...)
 - overcoming **skill shortage**
 - gaps in **standardisation**

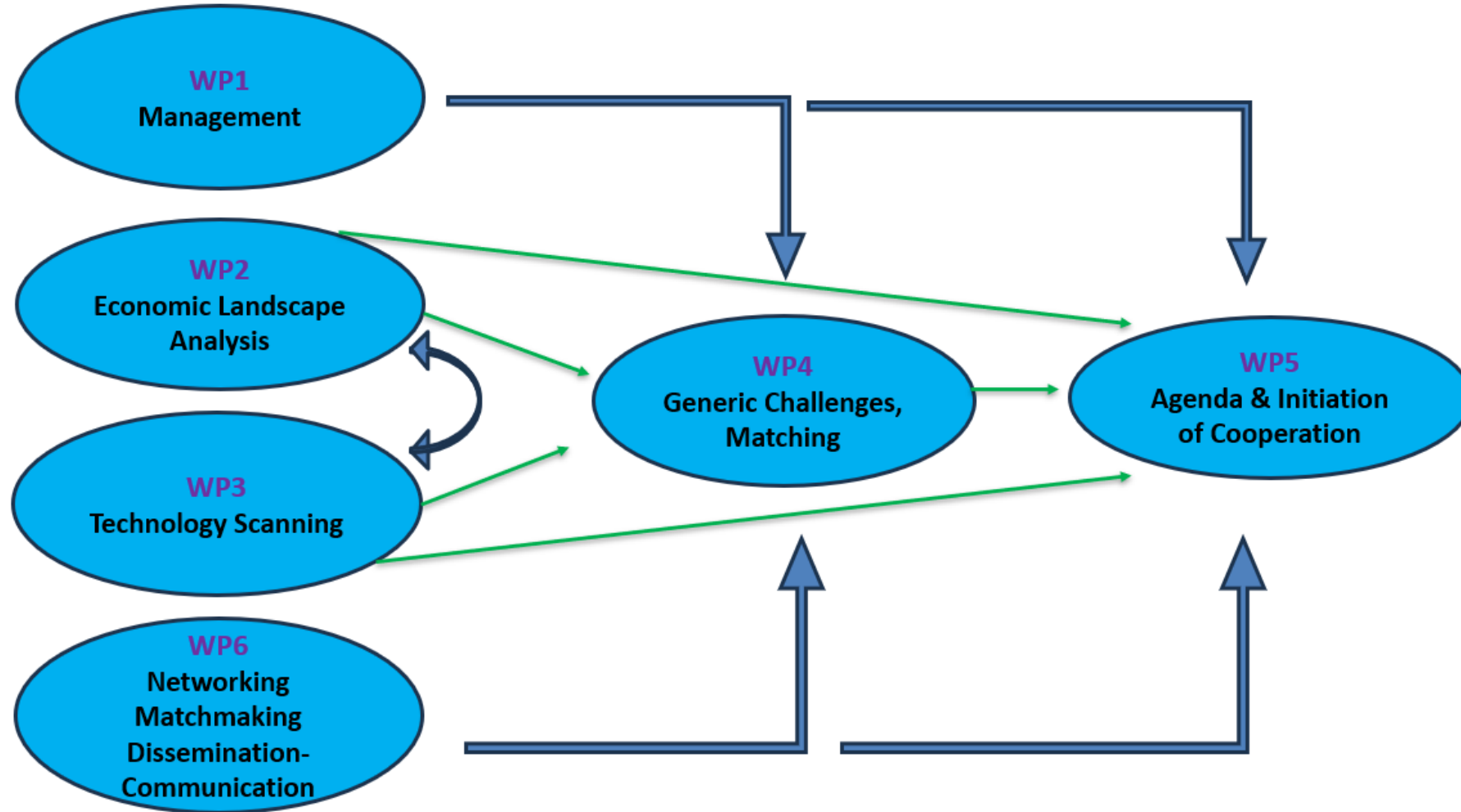
Objectives of International Cooperation in Semiconductor

- To implement and strengthen the **DPs & TTC** in close cooperation with the EC
- To build **balanced semiconductor partnerships** with like-minded countries
- To set out cooperative framework on **initiatives of mutual interest**
- To identify and support the establishment of the **most promising scientific international collaborations** and **to overcome the main challenges in the Roadmaps**
- To consolidate **sovereignty through skills**
=> *Skill Roadmap* aligned with **Research and Industrial Roadmaps**, Strengthen *scientific and technological competences* through international cooperation, Develop *students skills*, Attract *international students*
- To organize **matchmaking** bilateral and multilateral events
- To support the growth of the **Semiconductor industry in growing markets** through **focused research alliances** based on awareness of advanced research activities
- To strengthen **Europe's position** in emerging **technologies** and global **value chains** in this area and to contribute to the **EU Chips Act, Green deal and Digital Agenda**

Objectives



ICOS Concept



Current cooperation topics in the DPs/TTCs following bilateral events

Countries for cooperation

- India
- Japan
- ROK
- Singapore

- India
- Japan
- ROK
- Singapore

Topics of mutual interests with EU

Heterogeneous integration & Packaging

**Cutting edge processing technologies
Energy efficient computing & Memories**

Main challenges in Roadmaps

- 3D integration
- Power efficient chiplets
- Advanced Packaging with optical, electrical, mechanical, thermal, RF, bio requirements
- 3D integration design

- Multigate & 3D devices
- FDSOI
- Advanced materials (2D...)
- BEOL technologies
- BEOL functionalities (oxide semiconductors, ferroics...) & NVM
- Buried Power Rail
- High-NA EUV
- In-memory, neuromorphic computing
- Cryoelectronics
- Circuit and System Design (DTCO)

Current cooperation topics in the DPs/TTCs following bilateral events

Countries for cooperation

- India
- Japan

- India
- Singapore

Topics of mutual interests with EU

Sustainable manufacturing

Advanced functionalities

Main challenges in Roadmaps

- Optimize use of resources (e.g. water, gases, chemicals, energy) and processes in production
- LCA assessment
- Recyclability, repair, reconfiguring, re-use

- Wide & ultrawide band gap for power
- Highly sensitive and more versatile sensors
- Photonic chips for optical interconnects and quantum processing
- Efficient energy harvesters
- Flexible electronics
- Advanced design tools, including multi-physics simulation

Development of International Cooperation



Impact

Take into account the impact:
Market growth, Production
share, Emerging Technology
for new Markets, New
knowledge for disruptive
technology, Environmental,
Societal



Strengths

Strengthen International Cooperation with countries
having Strengths in the value chain (e.g. Materials,
Equipments, etc.)
and/or
Strengthen International Cooperation with
Countries and Institutions having Strengths in some
Technologies useful for important EU Applications



Cooperation

- New topics for DPs and TTCs
- New International Calls
- Bilateral Cooperation between Institutions
 - Exchange of Researchers/PhDs



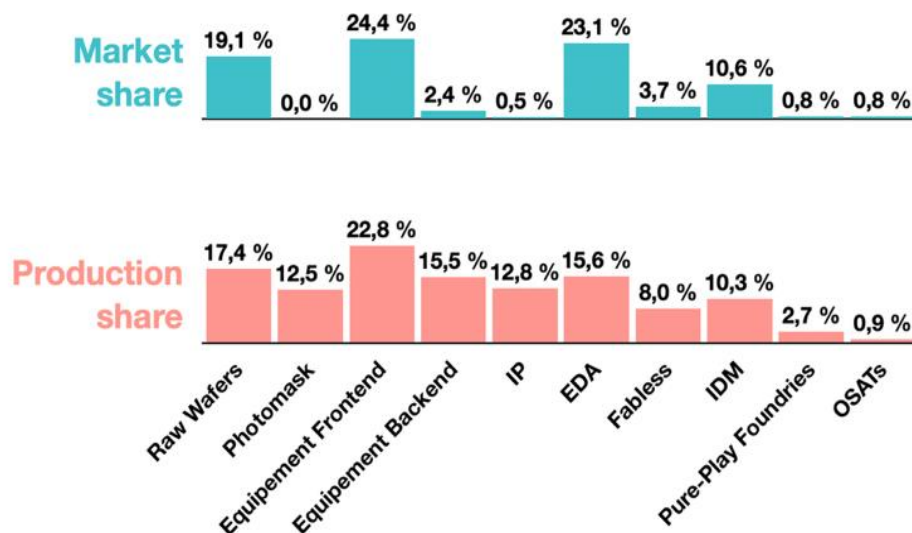
Market & Production shares in the value chain

=> Possible future cooperation topics in the value chain



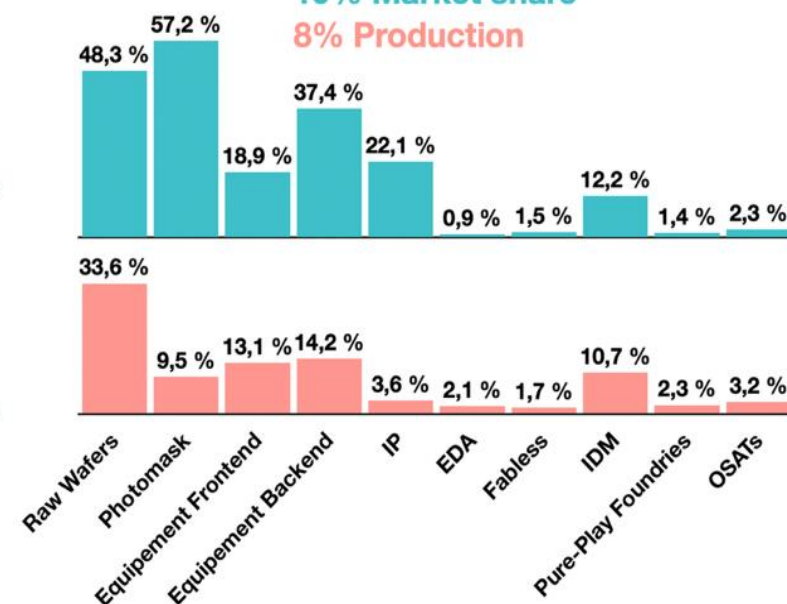
The EU

9% Market share
10% Production



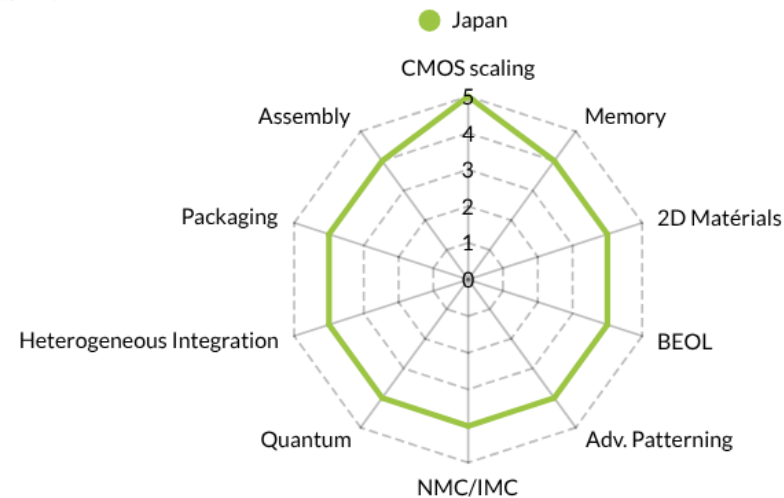
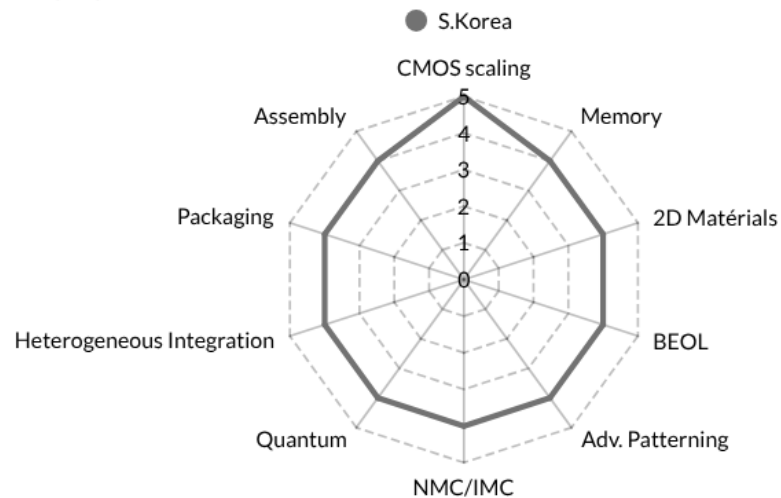
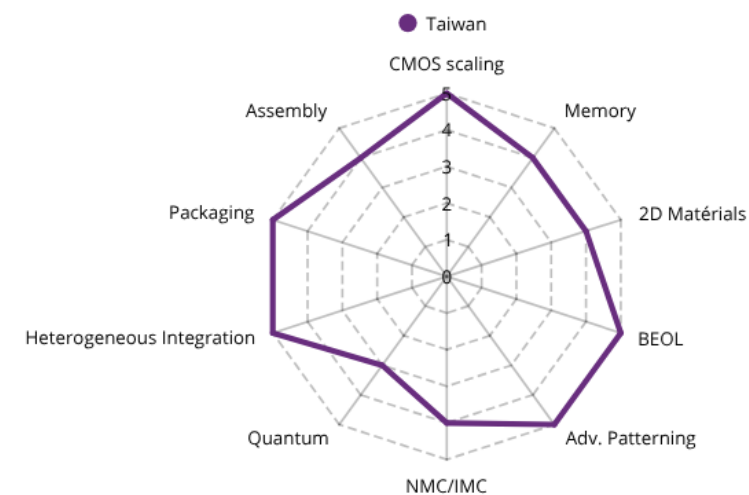
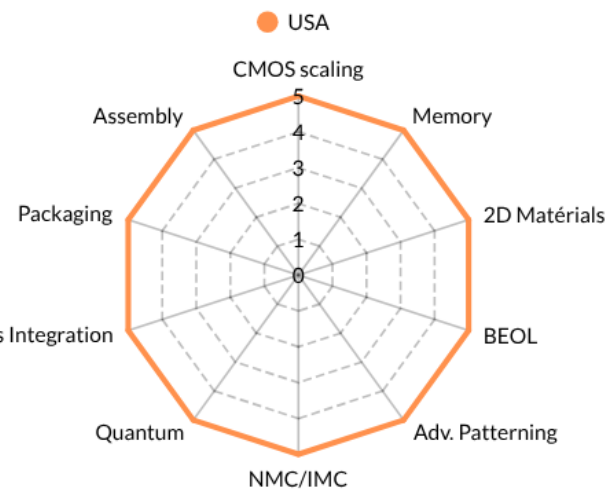
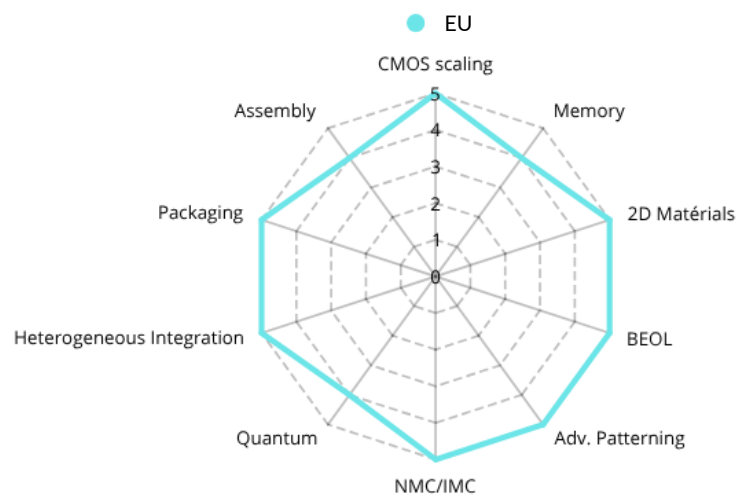
Japan

10% Market share
8% Production

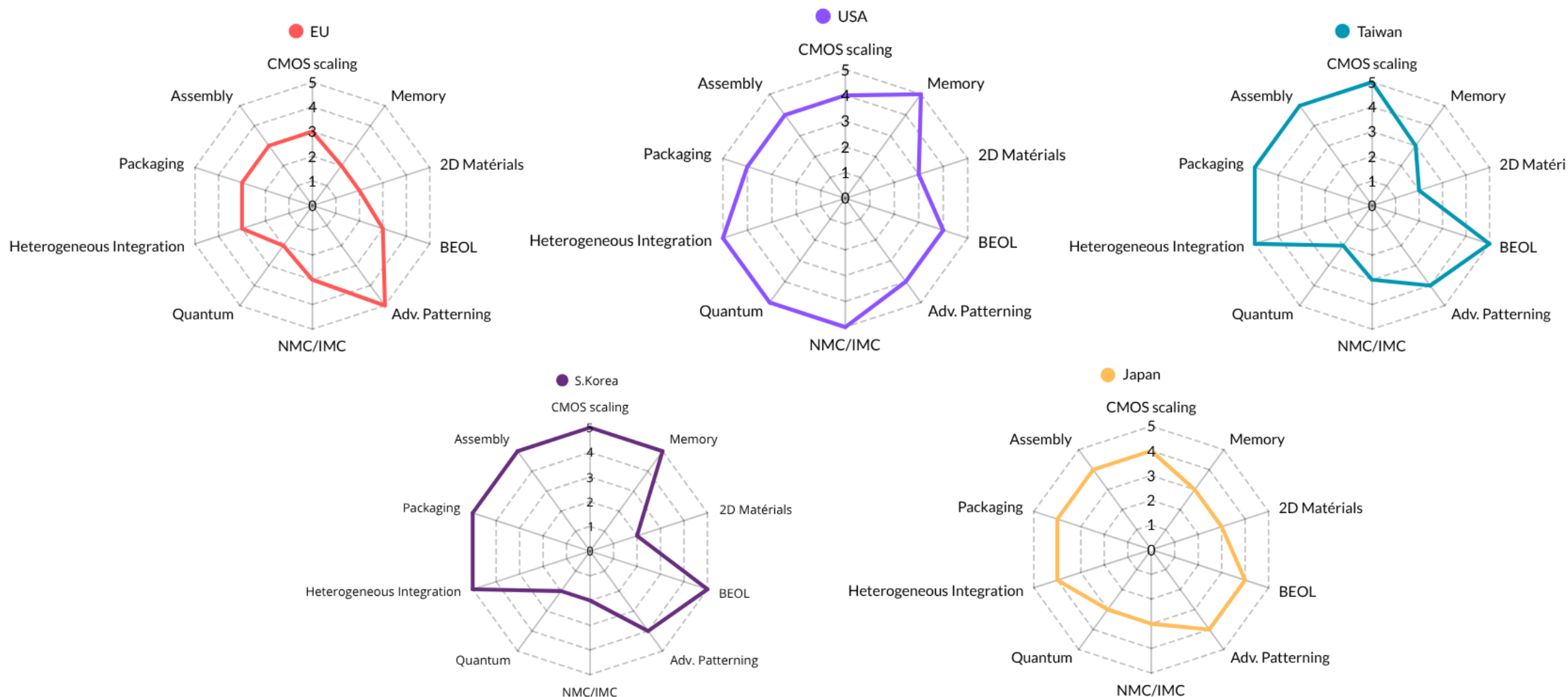


Source: DECISION Etudes & Conseil

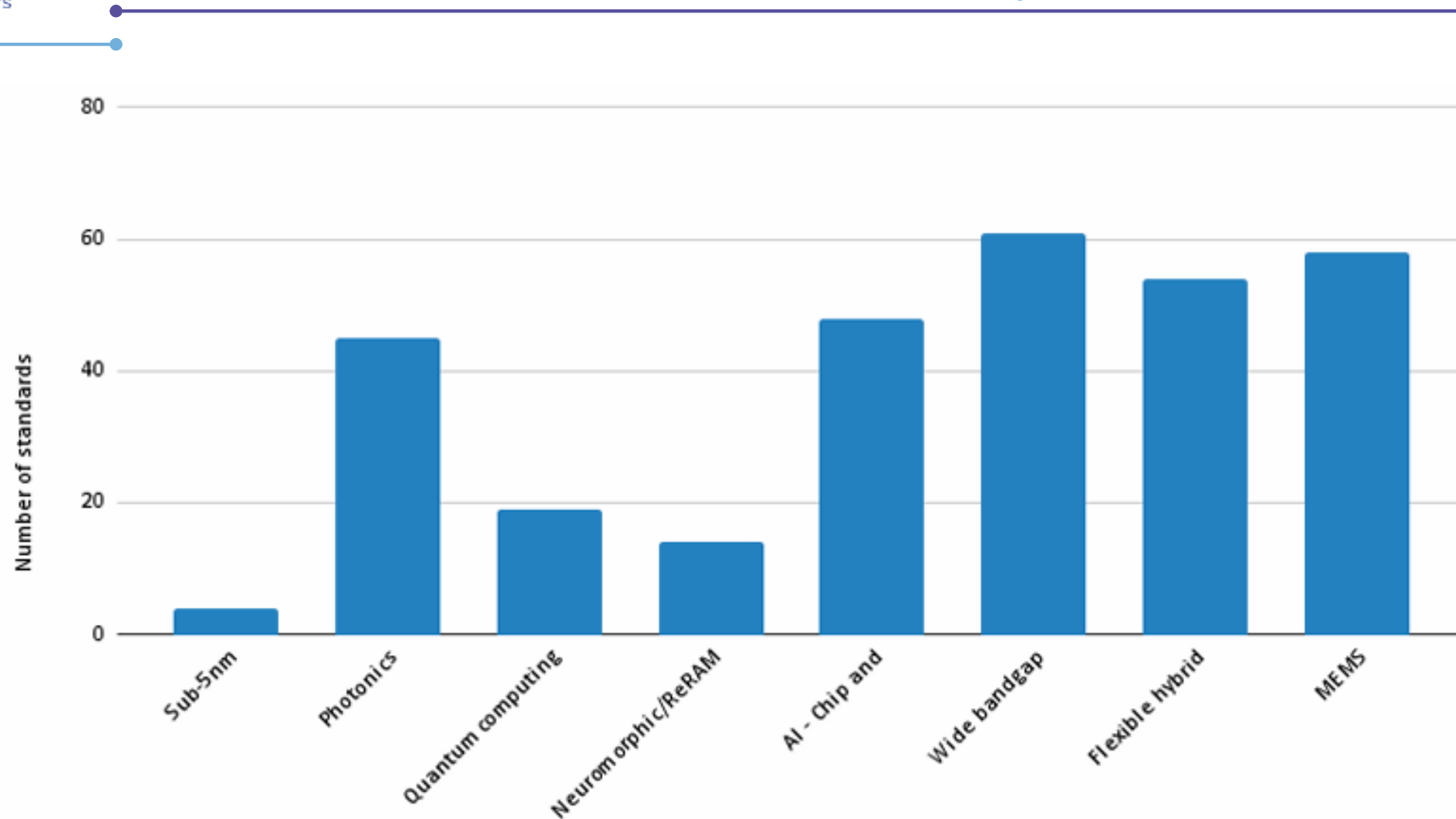
Strength matrix involving RTOs and Academia for Advanced Computing => Possible future technological cooperation topics for Academia/RTO



Strength matrix involving Industry for Advanced Computing => Technological cooperation topics for Industry (with Industry/Academia)



Number of standards vs Category modules or Components => Multilateral cooperation



Recent events (July 2024-December 2025)

=> Overall, 24 Multilateral and Bilateral Workshops with European Industrial & Academic communities and leading semiconductor countries have been organized by ICOS.

- **Online Workshop** on **EU-Japan Semiconductor Research Cooperation** (July 5, 2024): Coordination and writing of the 1 page-paper per topic and selection of sub-topics for **EU-Japan cooperation**
- **Joint EU-India semiconductors researchers Forum, Brussels**, (October 9, 2024)
- **2nd Semiconductor joint EU-ROK Researcher Forum, Jeju**, South Korea, June 16, 2025
- **1st Joint EU-Singapore Researchers Workshop on Semiconductors, Brussels**, July 8-9, 2025

Recent events (July 2024-December 2025)

- **ICOS Workshop** “Emerging technologies in Advanced Computation, Advanced Functionalities, Ground-breaking Technologies: Impact on International Cooperation”, **ESSERC 2024, Bruges**, Sept 9, 2024
- **ICOS talk** “EU and non-EU strengths, weaknesses, dependencies, opportunities for international collaboration, **Semicon Europa, Munich**, Nov. 12, 2024
- **ICOS talk** « Horizon Europe ICOS - International Cooperation on Semiconductors”, **EFECS, Ghent**, Dec. 5, 2024
- **ICOS Workshop** “Key emerging technologies for future industrial applications”, **EUROSOI-ULIS, Warsaw**, May 12-13, 2025
- **ICOS talk** “Horizon Europe ICOS: International Cooperation on Semiconductors for European Economic Resilience”, **Semicon Europa, Munich**, Nov. 20, 2025
- **ICOS Workshop** “Key Results of International Cooperation on Semiconductors for European Economic Resilience” **EFECS, Malta**, Dec. 4, 2025

- The **last ICOS results** presented at this ECS side event:
 - Monitoring semiconductor value chains
 - Updated technology scanning and foresight
 - Priorities for cooperation
 - Engagement with stakeholders in international cooperation
 - Policy advice on international cooperation in semiconductors

- During its three years of operation, ICOS has implemented, strengthened and developed partnerships with leading semiconductor countries for European economic resilience, in close cooperation with the European Commission

THANK YOU



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This Event is associated with



And is a side event of the

**ECS BROKERAGE
EVENT 2026**

www.icos-semiconductors.eu

ICoS Final Event – Results & Recommendations on
International Cooperation on Semiconductors for
European Economic Resilience